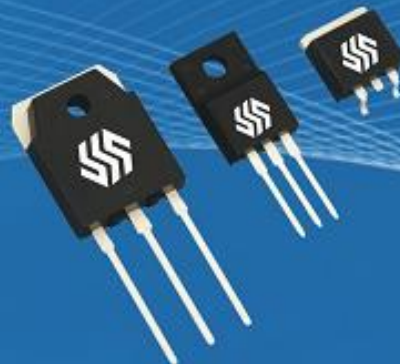




SUPER-SEMI



## SUPER-MOSFET

Super Junction Metal Oxide Semiconductor Field Effect Transistor

650V Super Junction Power MOSFET Gen- II  
SST65R280S2

Rev. 1.1  
Sep. 2019

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# SST65R280S2

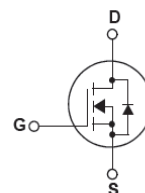
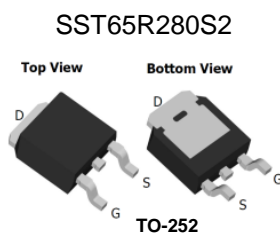
## 650V N-Channel Super-Junction MOSFET Gen-II

### Description

SJ-FET is new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance. This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. SJ-FET is suitable for various AC/DC power conversion in switching mode operation for higher efficiency.

### Features

- Multi-Epi process SJ-FET
- 700V @T<sub>J</sub> = 150 °C
- Typ. RDS(on) = 0.23Ω
- Ultra Low Gate Charge (typ. Q<sub>g</sub> = 28nC)
- 100% avalanche tested



### Absolute Maximum Ratings

Symbol	Parameter	SST65R280S2	Unit
V <sub>DSS</sub>	Drain-Source Voltage	650	V
I <sub>D</sub>	Drain Current -Continuous (TC = 25°C) -Continuous (TC = 100°C)	15* 9.5*	A
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	58	A
V <sub>GSS</sub>	Gate-Source voltage	±30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	235	mJ
I <sub>AS</sub>	Avalanche current, repetitive or not-repetitive (pulse width limited by T <sub>J</sub> max)	2.8	A
dv/dt	Peak Diode Recovery dv/dt (Note 3)	15	V/ns
dVds/dt	Drain Source voltage slope (V <sub>ds</sub> =480V)	50	V/ns
P <sub>D</sub>	Power Dissipation (TC = 25°C)	120	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering Purpose, 1/16" from Case for 10 Seconds	260	°C

\* Drain current limited by maximum junction temperature. Maximum duty cycle D=0.75

### Thermal Characteristics

Symbol	Parameter	SST65R280S2	Unit
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	1	°C/W
R <sub>θCS</sub>	Thermal Resistance, Case-to-Sink Typ.	0.5	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	62	°C/W



# Electrical Characteristics TC = 25°C unless otherwise noted

SST65R280S2 650V N-Channel Super-Junction MOSFET Gen-II

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 25°C	650	-	-	V
		V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 150°C	-	700	-	V
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250μA, Referenced to 25°C	-	0.6	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V -T <sub>C</sub> = 125°C	-	-	1 100	μA μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30V, V <sub>DS</sub> = 0V	-	-	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30V, V <sub>DS</sub> = 0V	-	-	-100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2.0	3.0	4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 7.5A	-	0.23	0.28	Ω
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V, f = 1.0MHz	-	1050	-	pF
C <sub>oss</sub>	Output Capacitance		-	37	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	1.1	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 400V, I <sub>D</sub> = 8A, V <sub>GS</sub> = 10V (Note 4)	-	28	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	6.2	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	9.8	-	nC
R <sub>g</sub>	Gate resistance	f=1 MHz, open drain	-	13	-	Ω
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DS</sub> = 400V, I <sub>D</sub> = 8A R <sub>G</sub> = 15Ω, V <sub>GS</sub> = 12V (Note 4)	-	17	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	18	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	89	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	20	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		-	-	15	A
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		-	-	58	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 15A	-	0.9	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 400V, I <sub>S</sub> = 8A, dI <sub>F</sub> /dt = 100A/μs	-	285	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	3.1	-	μC
I <sub>rrm</sub>	Peak Reverse Recovery Current		-	22	-	A

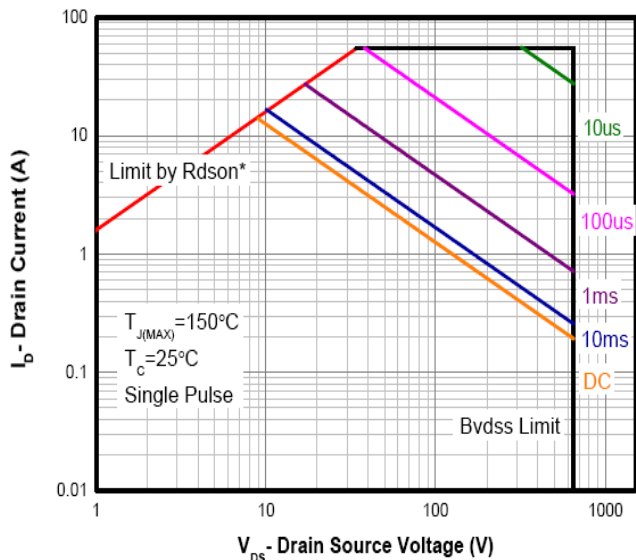
**NOTES:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I<sub>D</sub> = I<sub>AS</sub>, V<sub>DD</sub> = 50V, Starting T<sub>J</sub> = 25 °C
3. I<sub>SD</sub> ≤ I<sub>D</sub>, di/dt ≤ 200A/μs, V<sub>DP</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25 °C
4. Essentially Independent of Operating Temperature Typical Characteristics

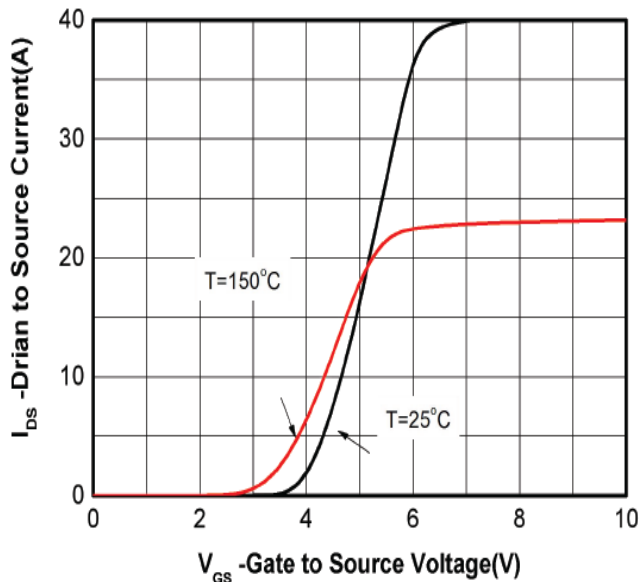


# Typical Performance Characteristics

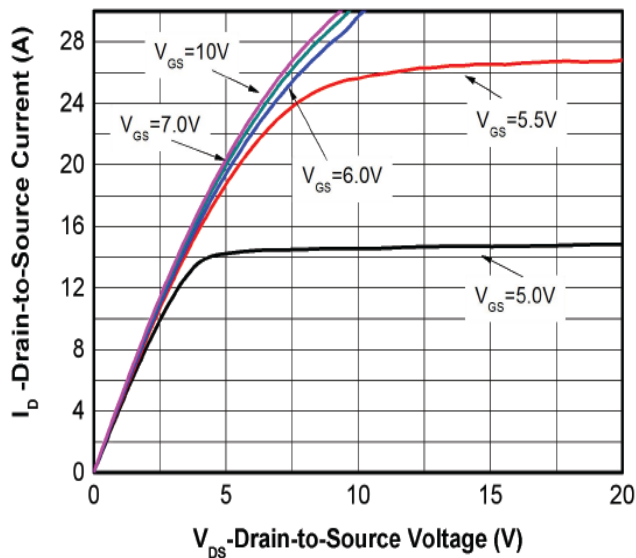
Safe operating area TC=25 °C  
Non FullPAK



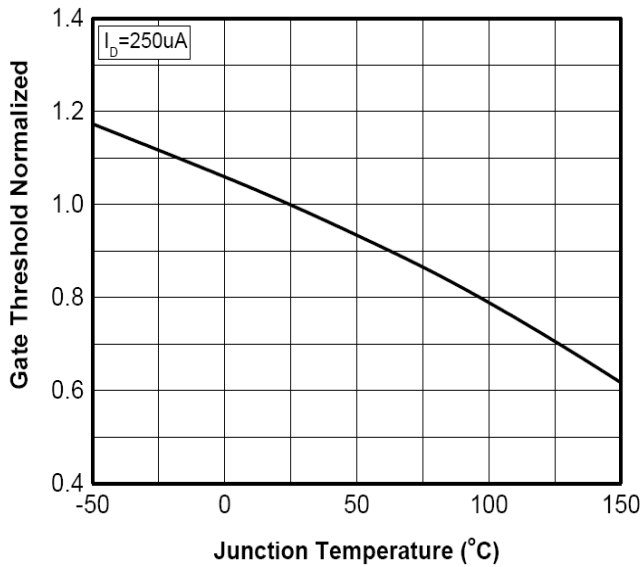
Typ. transfer characteristics



Typ. output characteristics  $T_j=25\text{ }^\circ\text{C}$



Normalized  $V_{GS(th)}$  characteristics

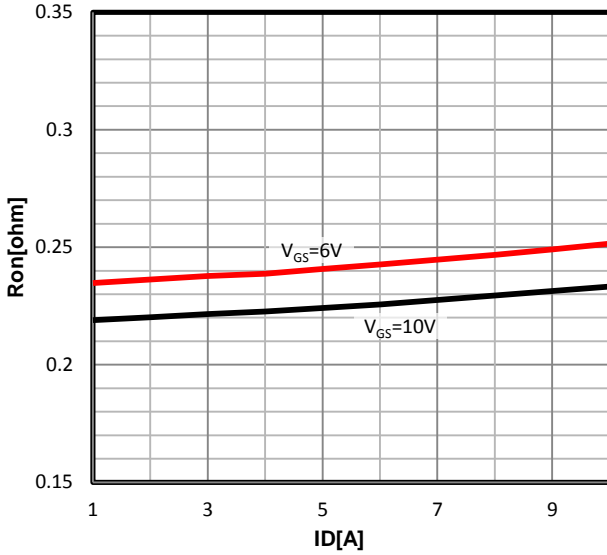


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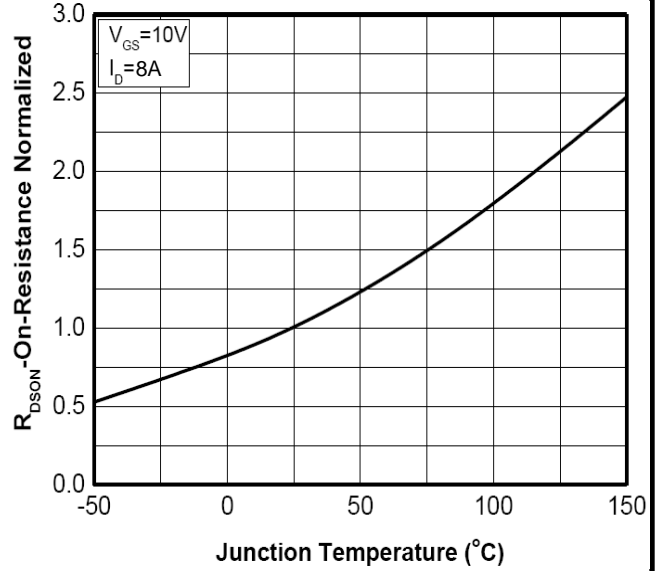


# Typical Performance Characteristics

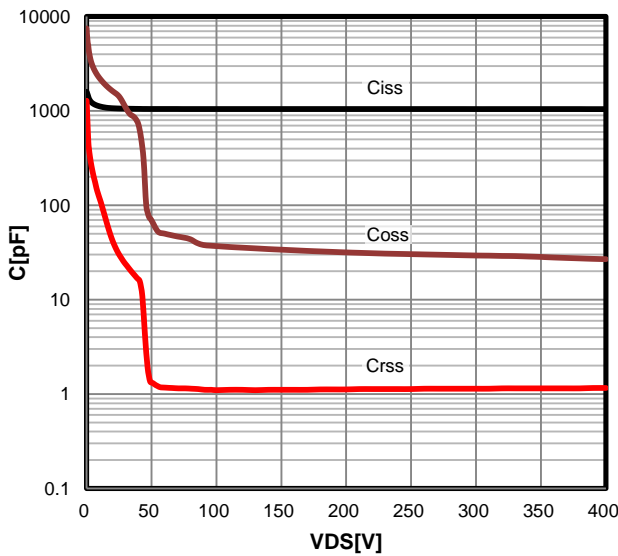
### Typ. drain-source on-state resistance



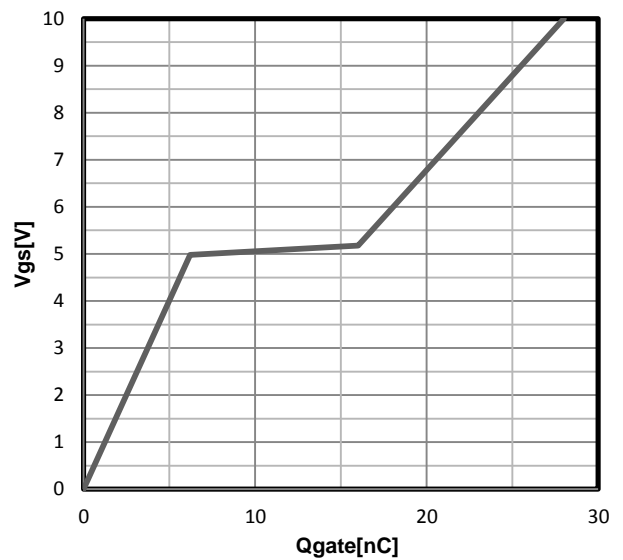
### Normalized on resistance vs temperature



### Typ. capacitances



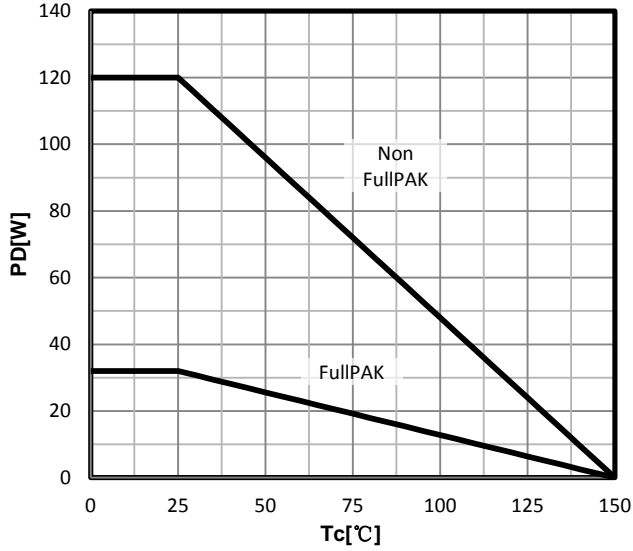
### Typ. gate charge characteristics



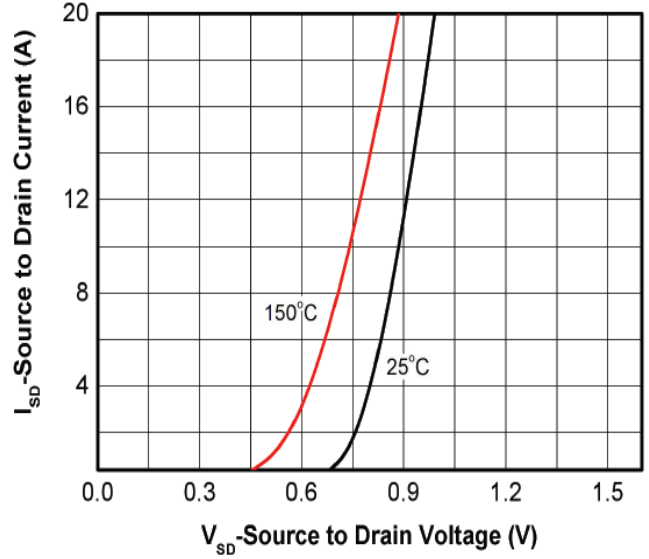


# Typical Performance Characteristics

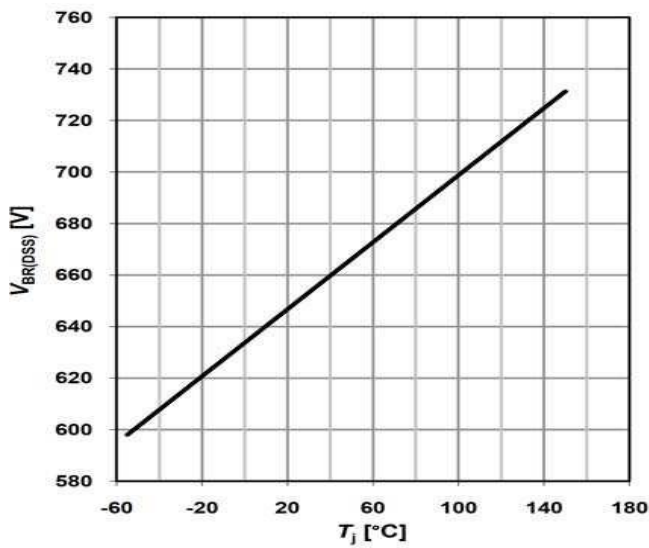
### Power dissipation



### Forward characteristics of reverse diode



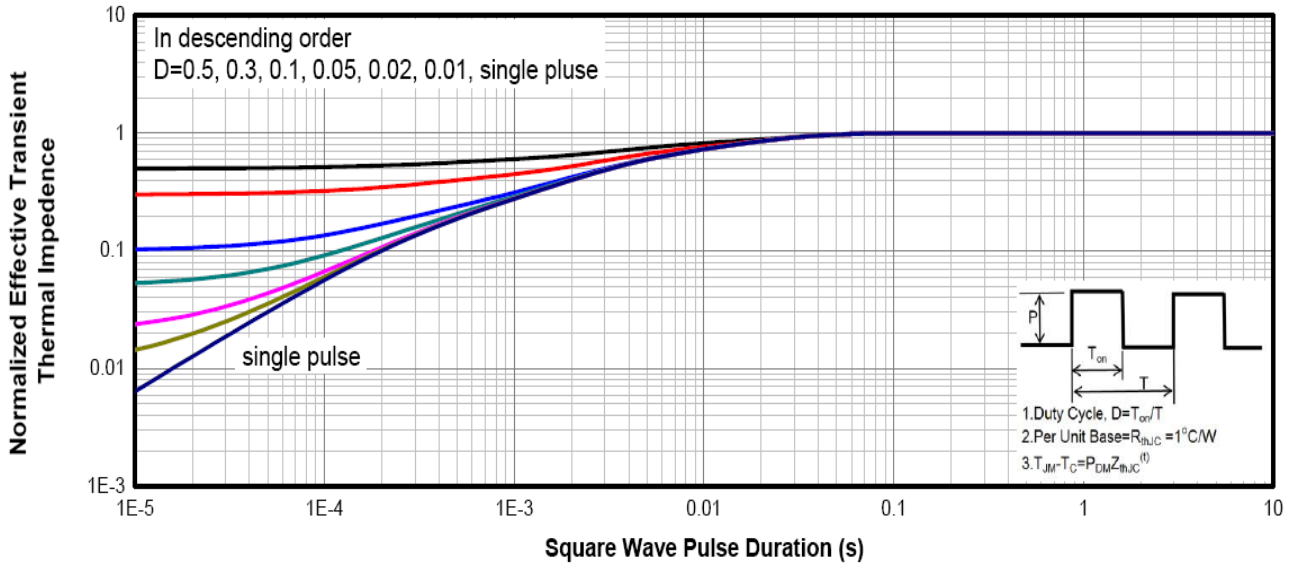
### Drain-source breakdown voltage





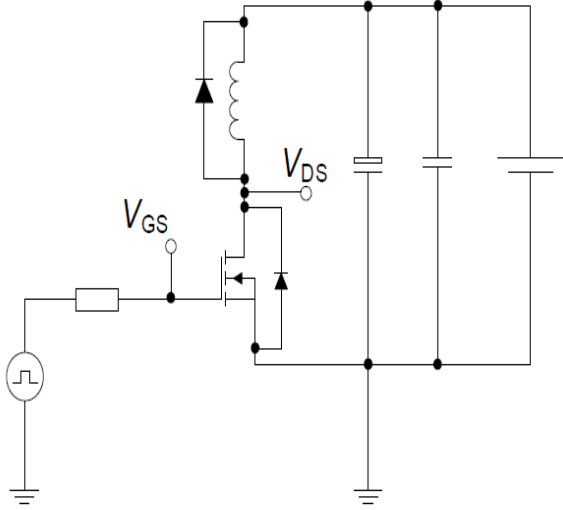
# Typical Performance Characteristics

Max. transient thermal impedance  
Non FullPAK

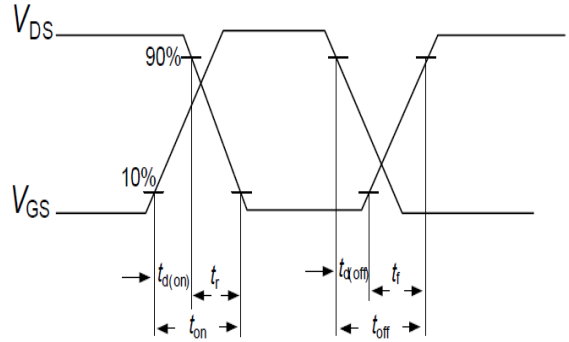


## Switching times test circuit and waveform for inductive load

Switching times test circuit for inductive load

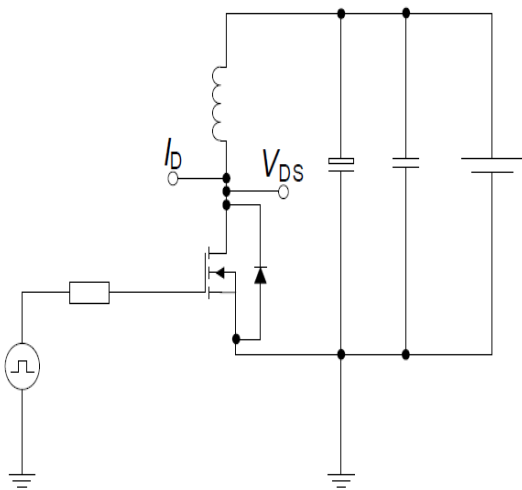


Switching time waveform

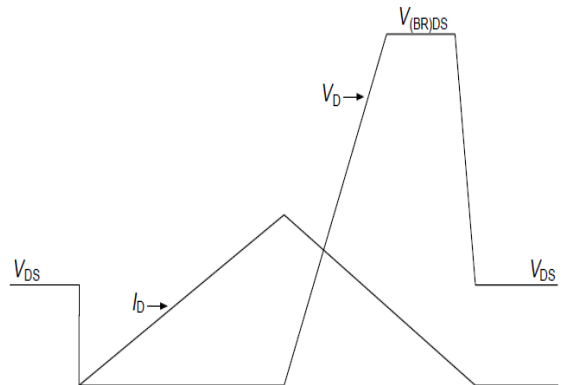


## Unclamped inductive load test circuit and waveform

Unclamped inductive load test circuit



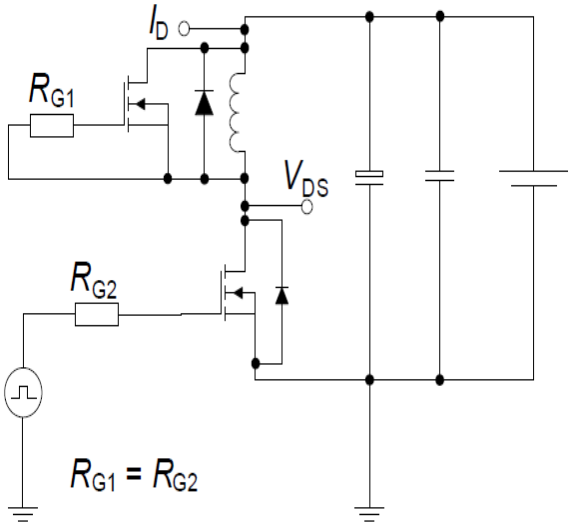
Unclamped inductive waveform



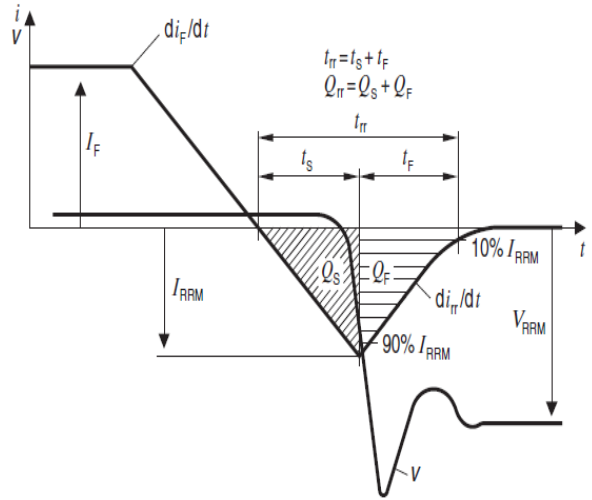


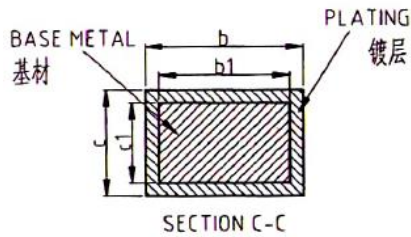
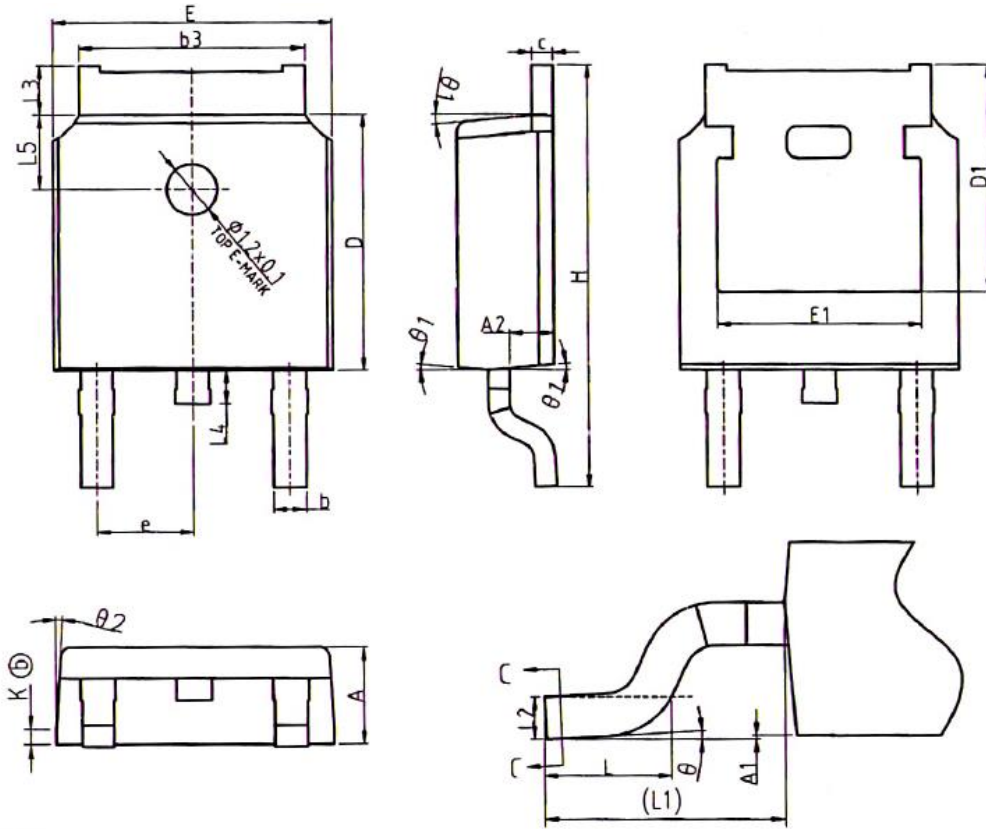
## Test circuit and waveform for diode characteristics

Test circuit for diode characteristics



Diode recovery waveform





COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
A	2.20	2.30	2.38
A1	0.00	-	0.10
A2	0.97	1.07	1.17
b	0.72	0.78	0.85
b1	0.71	0.76	0.81
b3	5.23	5.33	5.46
c	0.47	0.53	0.58
c1	0.46	0.51	0.56
D	6.00	6.10	6.20
D1	5.30REF		
E	6.50	6.60	6.70
E1	4.70	4.83	4.92
e	2.286BSC		
H	9.90	10.10	10.30
L	1.40	1.50	1.70
L1	2.90REF		
L2	0.51BSC		
L3	0.90	-	1.25
L4	0.60	0.80	1.00
L5	1.70	1.80	1.90
$\theta$	0°	-	8°
$\theta 1$	5°	7°	9°
$\theta 2$	5°	7°	9°
K	0.40REF		



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